

STRUCTURE Silicon Monolithic Integrated Circuit

Step down DC/DC converter Controller IC for NOTE PC **TYPE**

PRODUCT SERIES BD95371MUV

• Built in H³Reg DC/DC controller **FEATURES**

Switching Frequency Variable (f=200kHz~500kHz)

O ABSOLUTE MAXIMUM RATINGS (Ta=25°C)

J ABSOLUTE MAXIMUM RATING	3 (1a=25 C)		
Parameter	Symbol	Limit	Unit
Input Voltage 1	VCC	7 *1*2	V
Input Voltage 2	VDD	7 *1*2	V
Input Voltage 3	VIN	28 *1*2	V
BOOT Voltage	BOOT	35 *1*2	V
BOOT-SW Voltage	BOOT-SW	7 *1*2	V
HG-SW Voltage	HG-SW	7 *1*2	V
LG Voltage	LG	VDD	V
Output Voltage	VOUT/Is+/Is-	VCC	V
EN Input Voltage	EN	7 *1	V
Power Dissipation 1	Pd1	0.34*3	W
Power Dissipation 2	Pd2	0.70*4	W
Power Dissipation 3	Pd3	2.20*5	W
Power Dissipation 4	Pd4	3.56* ⁶	W
Operating Temperature Range	Topr	-10~+100	°C
Storage Temperature Range	Tstg	-55 ~ +150	°C
Maximum Junction Temperature	Tjmax	+150	°C

^{*1} Not to exceed Pd.

○ OPERATING CONDITIONS (Ta=25°C)

Parameter	Symbol	MIN	MAX	Unit
Input Voltage 1	VCC	4.5	5.5	V
Input Voltage 2	VDD	4.5	5.5	V
Input Voltage 3	VIN	4.5	25	V
BOOT Voltage	BOOT	4.5	30	V
SW Voltage	SW	-0.7	25	V
BOOT-SW Voltage	BOOT-SW	4.5	5.5	V
EN Input Voltage	EN	0	5.5	V
Is Input Voltage	ls+/ls-	0.7	2.7	V
MIN ON Time	Tonmin	-	80	ns

[★] This product is not designed for protection against radioactive rays.

^{*2} Instantaneous surge voltage, back electromotive force and voltage under less than 10% duty cycle.

^{*3} Reduced by 2.7mW/°C for each increase in Ta of 1°C over 25°C. (when don't mounted on a heat radiation board)

*4 Reduced by 5.6mW/°C for increase in Ta of 1°C over 25°C. (when mounted on a board 70.0mm×70.0mm×1.6mm 1-layer Glass-epoxy PCB, copper foil area: 10.29mm²)

*5 Reduced by 17.6mW/°C for increase in Ta of 1°C over 25°C. (when mounted on a board 70.0mm×70.0mm×1.6mm 4-layer Glass-epoxy PCB, copper foil area: 10.29mm² 2,3-layer copper foil area: 5505mm²)

*6 Reduced by 28.5mW/°C for increase in Ta of 1°C over 25°C. (when mounted on a board 70.0mm×70.0mm×1.6mm 4-layer Glass-epoxy PCB, copper foil area: 5505mm²)

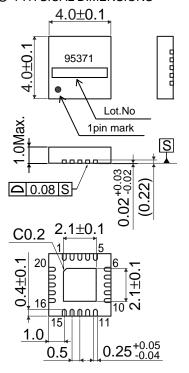


 $\bigcirc \texttt{ELECTRICAL\ CHARACTERISTICS\ (unless\ otherwise\ noted,\ Ta=25\%\ \ VCC=5V,VDD=5V,EN=3V,VIN=12V,VOUT=1.05V,R_{FS}=36k\Omega)}$

LECTRICAL CHARACTERISTICS (unless	outerwise noted, 1a=				v001=1.05	0 V, NFS=30K 12 /
Parameter	Symbol	Symbol Standard Value			Unit	Condition
	-,	MIN	TYP	MAX	- '	
[Whole Device]	1		4500	4000		
VCC Bias Current	lcc	-	1500	1800	μΑ	
VCC Standby Current	lccstb	-	0	10	μΑ	EN=0V
VIN Bias Current	lin	-	30	80	μΑ	
VIN Standby Current	linstb	-	0	10	μΑ	EN=0V
EN Low Voltage	VEN_low	GND	-	0.8	V	
EN HighVoltage	VENth_con	2.3	_	3.8	V	
(Forced Continuous mode)	V LINUI_COIT	2.5	_	5.0	V	
EN HighVoltage (SLLM Mode)	VENth_sllm	4.5	-	5.5	V	
EN Bias Current	len	-	15	25	μΑ	EN=3V
[Under Voltage Locked Out]		II.			,	- 1
VCC threshold voltage	Vcc_UVLO	3.7	4.0	4.3	V	VCC:Sweep up
VCC hysteresis voltage	dVcc_UVLO	100	160	220	mV	VCC:Sweep down
[H ³ REG Control]	******					
ON Time	Ton	194	219	244	ns	
MAX ON Time	Tonmax	-	3.5	-	μs	
MIN OFF Time	Toffmin	-	490	700	ns	
[FET Driver]						,
HG Higher side ON resistor	HGhon	-	3.0	6.0	Ω	
HG Lower side ON resistor	HGlon	-	2.0	4.0	Ω	
LG Higher side ON resistor	LGhon	-	3.0	6.0	Ω	
LG Lower side ON resistor	LGlon	-	0.5	1.0	Ω	
[SCP]						,
SCP strat-up Voltage	Vscp	0.345	0.420	0.495	V	
SCP delay time	Tscp	-	2.5	-	ms	
[OVP]						
FB threshold voltage	Vovp	0.825	0.900	0.975	V	
[Soft start]	•		•			·
Charge current	Iss	1	2	3	μΑ	
Standby voltage	Vss_stb	-	-	50	m۷	
[Current Limit Block]						
Setting Current	lilim	-	10	-	μΑ	
Current limit threshold	llim	75	100	125	mV	RILIM=100kΩ
[Output Voltage setting]						
VOUT typical voltage	REF	0.743	0.750	0.757	V	
Is+ Input current	lls+	-1	0	1	μΑ	Is+=1.05V
Is- Input current	lls-	-1	0	1	μΑ	Is-=1.05V
[Power Good]						
FB Power Good	V_{PGOOD}	0.38	0.47	0.56	V	
Discharge ON resistor	Ronpgood	-	50	150	Ω	
[BOOT Diode]	•					
VF voltage	VF	0.4	0.5	0.6	V	IF=1mA



O PHYSICAL DIMENSIONS

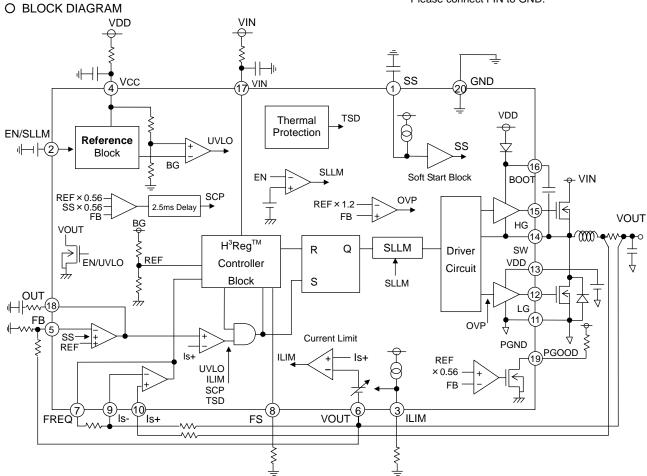


VQFN020V4040 (Unit:mm)

O Pin Number Pin Name

Pin	PIN name	
number	1 IIV Hame	
1	SS	
2 3	EN/SLLM	
3	ILIM	
4 5 6	VCC	
5	FB	
	VOUT	
7	FREQ	
8	FS	
9	ls-	
10	ls+	
11	PGND	
12	LG	
13	VDD	
14	SW	
15	HG	
16	BOOT	
17	VIN	
18	OUT	
19	PGOOD	
20	GND	
reverse	FIN	

Please connect FIN to GND.





Operation Notes

1. Absolute maximum ratings

An excess in the absolute maximum ratings, such as supply voltage, temperature range of operating conditions, etc., can break down the devices, thus making impossible to identify breaking mode, such as a short circuit or an open circuit. If any over rated values will expect to exceed the absolute maximum ratings, consider adding circuit protection devices, such as fuses.

2. Connecting the power supply connector backward

Connecting of the power supply in reverse polarity can damage IC. Take precautions when connecting the power supply lines. An external direction diode can be added.

3. Power supply lines

Design PCB layout pattern to provide low impedance GND and supply lines. To obtain a low noise ground and supply line, separate the ground section and supply lines of the digital and analog blocks. Furthermore, for all power supply terminals to ICs, connect a capacitor between the power supply and the GND terminal. When applying electrolytic capacitors in the circuit, not that capacitance characteristic values are reduced at low temperatures.

4. GND voltage

The potential of GND pin must be minimum potential in all operating conditions.

5. Thermal design

Use a thermal design that allows for a sufficient margin in light of the power dissipation (Pd) in actual operating conditions.

6. Inter-pin shorts and mounting errors

Use caution when positioning the IC for mounting on printed circuit boards. The IC may be damaged if there is any connection error or if pins are shorted together.

7. Actions in strong electromagnetic field

Use caution when using the IC in the presence of a strong electromagnetic field as doing so may cause the IC to malfunction.

8. ASO

When using the IC, set the output transistor so that it does not exceed absolute maximum ratings or ASO.

9. Thermal shutdown circuit

The IC incorporates a built-in thermal shutdown circuit (TSD circuit). The thermal shutdown circuit (TSD circuit) is designed only to shut the IC off to prevent thermal runaway. It is not designed to protect the IC or guarantee its operation. Do not continue to use the IC after operating this circuit or use the IC in an environment where the operation of this circuit is assumed.

	TSD on temperature [°C] (typ.)	Hysteresis temperature [°C](typ.)
BD95371MUV	175	15

10. Ground Wiring Pattern

When using both small signal and large current GND patterns, it is recommended to isolate the two ground patterns, placing a single ground point at the ground potential of application so that the pattern wiring resistance and voltage variations caused by large currents do not cause variations in the small signal ground voltage. Be careful not to change the GND wiring pattern of any external components, either.

11. Heat sink (FIN)

Since the heat sink (FIN) is connected with the Sub, short it to the GND.

Notes

No copying or reproduction of this document, in part or in whole, is permitted without the consent of ROHM Co.,Ltd.

The content specified herein is subject to change for improvement without notice.

The content specified herein is for the purpose of introducing ROHM's products (hereinafter "Products"). If you wish to use any such Product, please be sure to refer to the specifications, which can be obtained from ROHM upon request.

Examples of application circuits, circuit constants and any other information contained herein illustrate the standard usage and operations of the Products. The peripheral conditions must be taken into account when designing circuits for mass production.

Great care was taken in ensuring the accuracy of the information specified in this document. However, should you incur any damage arising from any inaccuracy or misprint of such information, ROHM shall bear no responsibility for such damage.

The technical information specified herein is intended only to show the typical functions of and examples of application circuits for the Products. ROHM does not grant you, explicitly or implicitly, any license to use or exercise intellectual property or other rights held by ROHM and other parties. ROHM shall bear no responsibility whatsoever for any dispute arising from the use of such technical information.

The Products specified in this document are intended to be used with general-use electronic equipment or devices (such as audio visual equipment, office-automation equipment, communication devices, electronic appliances and amusement devices).

The Products specified in this document are not designed to be radiation tolerant.

While ROHM always makes efforts to enhance the quality and reliability of its Products, a Product may fail or malfunction for a variety of reasons.

Please be sure to implement in your equipment using the Products safety measures to guard against the possibility of physical injury, fire or any other damage caused in the event of the failure of any Product, such as derating, redundancy, fire control and fail-safe designs. ROHM shall bear no responsibility whatsoever for your use of any Product outside of the prescribed scope or not in accordance with the instruction manual.

The Products are not designed or manufactured to be used with any equipment, device or system which requires an extremely high level of reliability the failure or malfunction of which may result in a direct threat to human life or create a risk of human injury (such as a medical instrument, transportation equipment, aerospace machinery, nuclear-reactor controller, fuel-controller or other safety device). ROHM shall bear no responsibility in any way for use of any of the Products for the above special purposes. If a Product is intended to be used for any such special purpose, please contact a ROHM sales representative before purchasing.

If you intend to export or ship overseas any Product or technology specified herein that may be controlled under the Foreign Exchange and the Foreign Trade Law, you will be required to obtain a license or permit under the Law.



Thank you for your accessing to ROHM product informations.

More detail product informations and catalogs are available, please contact us.

ROHM Customer Support System

http://www.rohm.com/contact/